

Component Title:

TRANSISTORS, POWER MOSFET Type BUY \*\*CS\*\*; N-CHANNEL, BASED ON TYP BUY25CS

Page 1 Appl. No.

	3	Executive Member:	German Space A	gency at DLR	Date: 19/10/2023	319F	
Components (includ	ling series and families) s	submitted for Extension	of Qualification A	Approval:			1
ESCC COMPONENT NO.	VARIANTS	RANGE OF COMPONENTS		BASED ON	TEST VEHICLE / S	COMPONENT SIMILAR	
5205/026 5205/027 5205/030	. 02 5205/027 01			BUY25CS12J-01 BUY25CS04J-01 BUY25CS54A-01 BUY25CS12K-01 BUY25CS12K-11 BUY25CS45B-01	BUY25CS12K-02	х	
	¥ = 1				Additional test vehicle for extension MOQ see Annex 1		
Component M	lanufacturer 2	Location of Ma	nufacturing Plant(	(s) 3			4
Infineon Technologic		Villach, Austria for S Neubiberg, Germany	ilicon		Date of original qualificat Date: 01/01/2012	ion approval:	
					Certificate Ref No. 31	19, initial: Aug. 2012	
ESCC Specifications Maintenance of qual Generic: 5000	lification testing: Issue: 10	Deviations to LVT testing and Detail Specification used:  No ⊠ Yes □ (supply details in Box 15)			Qualification Extension Report reference and date: 2236LR20, lss. 1a, Sept 2023 2236LR30, lss. 1a, Sept 2023		
Detail(s): 5205/03 5205/03 5205/03 5205/03	31 2 32 3	Deviation from current Specifications:  No ⊠ Yes □ (Supply details)			2117LR10, Iss. 1a, Sept 2023 2117LR13, Iss. 1b, Sept 2023 2117LR14, Iss. 1a, Sept 2023		
			P P		w . 5000 F . 15	,	8
Project Name	Testing Level	LAT		port or this application	on (those to ESCC listed file Quantity	Delivered	
Confidential:					,		
PID changes since s	tart of qualification	9	Current PID Ve	erified by:	Burak Gökgöz, German S at DLR	pace Agency 1	10
None □  Minor* ⊠  Major* □	*Provide details in box:				Name of Excutive Repres GEPID-P000, Issue 2h, 20 5491-P000, Issue 10, 21.0	.09.2023	
	See Annex 2 / Confide	ential					
Current Manufacturin	ng facilities surveyed by:	Burak Gökgöz	, German Space	Agency at DLR	on 19	-20/09/2023	1
		(Name of Exe	cutive Representa	ative)		(Date)	
Satisfactory:	Yes ⊠	No 🗆	Explain				
Report Reference:	INFINEON-AUD-D	LR-09-2023	-				



Addition new variants

Component Title: TRANSISTORS, POWER MOSFET Type BUY \*\*CS\*\*; N-CHANNEL, BASED ON TYP BUY25CS

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	xecutive Member.	Conne	ин ора	ce Agency at Di	LIX	Date. 19/10/2023			
series and families) sul	bmitted for Qualification	on Approva	ſ					L	1
VARIANTS	RANGE OF CO	MPONENT	s	BASED		TEST VEHICLE / S	COMPONENT SIMILAR		Т
MPONENT. NO.   VARIANTS   NAME OF COMM 5/026			BUY25CS12. BUY25CS04. BUY25CS54/ BUY25CS12/ BUY25CS12/		J-02 A-02 K-02 K-12	2 BUY25CS12K-02 12 12 2 2			
	-					Additional test vehicle for new variants SPQ see Annex 1			
nufacturer 2 AG .	Dresden, for Silicon				Gene	eric: 5000 Issue:	10	eation	4
Qualification Report Reference and date: 2236LR20, Iss. 1a, Sept 2023 2117LR10, Iss. 1a, Sept 2023 2117LR11, Iss. 1a, Sept 2023 2117LR13, Iss. 1b, Sept 2023 2117LR14, Iss. 1a, Sept 2023				eric PID: A6350	0-GEP	ID-P000, Issue 2h, 20.09.2			6
t of qualification	7	Current F	PID V	erified by	Bura	ak Gökgöz, German Space at DLR	Agency	_	8
* Details not published, onfidential annex 2.)	provided in				2000, Is	ssue 2h, 20.09.2023	ive		
facilities surveyed by:		Neubib	erg			Dresden			9
an Space Agency at DL	.R	19-20/09	9/2023			27/06/2023			
presentative)	<del>.</del>	(Date	e)			(Date)			
erence Yes ⊠	No □ Ex	kplain							
Data prmed Yes □	No 🖂				, DPA,	NCCS Yes	No		10
	Date:		(	(supply data)					
reports reviewed 21.03 Visit Report: MoM Infir Final Evaluation Repo	3.2023 neon On-Site Datarevirt:	iew.docx							
				Ref Nos. and pu	ırpose:				
	VARIANTS  03 04 02 04 05 06  ufacturer 2 AG  ference and date: t 2023 t 2023 t 2023 t 2023 t 2023 t 2023 t of qualification  Details not published, onfidential annex 2.)  facilities surveyed by: an Space Agency at DL presentative)  UD-DLR-09-2023  frence Yes   Data  Single Phase Qualification reports reviewed 21.0: Visit Report: MoM Infine Final Evaluation Report EHC5CCS_12_RadHailer  EHC5CCS_12_RadHailer  OCCS_12_RadHailer  OC	VARIANTS RANGE OF CO  03 04 02 04 05 06  ufacturer 2 Location of N Dresden, for Silicon Neubiberg, German  ference and date: tt 2023 tt 2023 tt 2023 tt 2023 tt of qualification 7  Details not published, provided in onfidential annex 2.)  facilities surveyed by: an Space Agency at DLR presentative)  UD-DLR-09-2023  trence Yes No   Date:  Single Phase Qualification - component evareports reviewed 21.03.2023 Visit Report: MoM Infinen On-Site Datarev Final Evaluation Report: EHC5CCS_12_RadHard_Evaluation-Test-F EHC5CCS_12_RadHard_Evaluation-Test-F	series and families) submitted for Qualification Approva  VARIANTS  RANGE OF COMPONENT  03 04 02 04 05 06  ufacturer 2	series and families) submitted for Qualification Approval  VARIANTS  RANGE OF COMPONENTS  03 04 02 04 05 06  ufacturer 2 Location of Manufacturing Plan Dresden, for Silicon Neubiberg, Germany for packing and  ference and date: t 2023 t 3023 t 2023	VARIANTS RANGE OF COMPONENTS BASED ON BUY25CS12 BUY25CS14 BUY25CS12 BUY25CS14 BUY25CS1	VARIANTS RANGE OF COMPONENTS BASED ON BUY25CS12J-02 BUY25CS12J-02 BUY25CS12J-02 BUY25CS12J-02 BUY25CS12J-02 BUY25CS12K-02 BUY25C	VARIANTS	Series and families    Submitted for Qualification Approval	Series and families  submitted for Qualification Approval



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Non com	pliance to ESCC requirements:			15
No.:	Specification	Paragraph	Non compliance	
Additional noncompli	tasks required to achieve full compliance f	or ESCC qualification or rationale for acceptability	of	16
	Manager Disposition			17
Application Action / Re			201	
Date:			B. Schade: Head of the Product Assurance and Safety Department	-

#### APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL Page 2 TRANSISTORS, POWER MOSFET Type BUY \*\*CS\*\*; N-CHANNEL, BASED ON TYP BUY25CS Component title: Appl. No. German Space Agency at DLR Date: 19/10/2023 Executive Member: 319F 12 $\boxtimes$ Failure Analysis, DPA, NCCS available: Yes No (Supply data) Ref. No's and purposes: 13 The undersigned hereby certifies on behalf of the ESCC Executive - that the above information is correct; - that the appropriate documentation has been evaluated; - that full compliance to all ESCC requirements is evidence (except as stated in box 15;) - that the reports and data are available at the ESCC Executive and therefore applies on behalf of DLR as the responsible Executive Member for ESCC qualification status to be extended to the component(s) listed herein. Burak Burak Digital signiert von Burak Goekgoez DN: C=DE, S=Nordrhein-Westfalen, L=Koeln, 0=Deutsches Zentrum fuer Luft- und Raumfahrt e.V. (DLR), SN=Goekgoez, G=Burak, CN= Burak Goekgoez Grund: Ich bin der Verfasser dieses Dokuments Ort: Bonn Datum: 2023.11.06 13:32:52+01'00' Foxit PDF Editor Version: 13.0.0 Burak Gökgöz, German Space Agency at DLR Date: 06/11/2023 (Signature of the Executive Coordinator)

Continuation of Boxes above:

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Executive Member: German Space Agency at DLR Date: 19/10/2023

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ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

Tests conducted in compliance with:

ESCC 5000 generic specification; Chart F4 (for ESCC/QPL parts); or PID-TFD (for ESCC/QML parts) or PID-TFD

Tests vehicle identification/description:

MoQ lot 1 MoQ lot 2	2236LR30_I1a, 2312A 2236LR20 I1a, 2248G	BUY65CS28A-01, EndSG BUY15CS57A-01, EnvMechSG
SPQ 1st qual lot SPQ 4th qual lot	2117LR10_I1a, 2311A 2117LR13_I1b, 2234A	BUY65CS08J-02, AssCapSG,
SPQ 5th qual lot	2117LR15_110, 2234A 2117LR14_11a, 2243F	BUY06CS45B-02, AssCapSG BUY25CS12K-02, EnvMechSG

Detail Specification reference:

5205/030; 5205/031; 5205/32; 5205/033

Chart F4A	Test	Tick when done	Conditions	Date Code	Tested Qty	N° of Rejects	Comments if not performed. Comments on Rejection
	Mechanical shock	$\boxtimes$	MIL-STD-750 TM2016	2248G 2243F	17 17	0	
	Vibration	$\boxtimes$	MIL-STD-750 TM2056	2248G 2243F	17 17	0	
0	Constant acceleration	×	MIL-STD-750 TM2006	2248G 2243F	17	0	
noagqr	Seal Fine leak Gross leak		MIL-STD-883 TM1014	2248G 2243F	17 17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
sal Si	Electrical Measurement		Intermediate and End-Point Electrical Measurements	2248G 2243F	17 17	0	Deviations from Chart F4A
hanic	External Visual		ESCC Basic spec 20500	2248G 2243F	17 17	0	
Meci	Thermal shock		MIL-STD-750 TM1056	22101		U	Temperature Cycling performed
Environmental/Mechanical Subgroup	Temperature Cycling	$\boxtimes$	MIL-STD-883 TM1010	2248G 2243F	17 17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
viron	Moisture Resistance	$\boxtimes$	MIL-STD-750 TM1021	2248G 2243F	17 17	0	Deviagone from Shart 1/1
En	Seal Fine leak Gross leak	$\boxtimes$	MIL-STD-883 TM1014	2248G 2243F	17 17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
	Electrical Measurement	$\boxtimes$	Intermediate and End-Point Electrical Measurements	2248G 2243F	17 17	0	Deviations from Chart F4A
	External Visual	$\boxtimes$	ESCC Basic spec 20500	2248G 2243F	17 17	0	
	Operating Life		ESCC 5000 Para. 8.19	2312A	16	0	
ance	Electrical Measurement		Intermediate and End-Point Electrical Measurements	2312A	16	0	
Endurance Subgroup	Seal Fine leak Gross leak		MIL-STD-883 TM1014	2312A	16	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
	External Visual Inspection	$\boxtimes$	ESCC Basic spec 20500	2312A	16	0	
_	Permanence of Marking		ESCC Basic Spec 24800				n.a. due to laser marking
apilit	Terminal Strength		ESCC 5000 Para. 8.18	2311A			N/A acc. ESCC Det. Spec 5205/033 §§ 2.1.1.2
Cap	Terminal Strength	$\boxtimes$	ESCC 5000 Para. 8.18	2234A	6	0	
Assembly Capability Subgroup	Internal Visual	$\boxtimes$	ESCC Basic Spec 20400	2311A 2234A	7 6	0	
	Bond Strength	$\boxtimes$	MIL-STD-750 TM 2037	2311A 2234A	7	0	
	Die Shear		MIL-STD-750 TM 2017	2311A 2234A	7 6	0	
Additional	Internal Gas Analyse	×	MIL-STD-883 TM 2036	2311A	6	0	On BUY65CS08J-02 Report: 2117LR10:11a



Addition new variants

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Date: 19/10/2023 Executive Member: German Space Agency at DLR

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ANNEX 1: LIST OF TESTS DONE TO SUPPORT **NEW** OF QUALIFICATION

Tests conducted in compliance with:

ESCC 5000 generic specification; Chart F4 (for ESCC/QPL parts); or PID-TFD (for ESCC/QML parts)

### Tests vehicle identification/description:

MoQ lot 2	2236LR20 I1a, 2248G	BUY15CS57A-01, EnvMechSG
SPQ 1st qual lot	2117LR10 I1a, 2311A	BUY65CS08J-02, AssCapSG
SPQ 3rd qual lot	2117LR11 I1a. 2302A	BUY25CS04J-02, EndSG
SPQ 4th qual lot	2117LR13 l1b, 2234A	BUY06CS45B-02, AssCapSG
SPQ 5th qual lot	2117LR14 I1a, 2243F	BUY25CS12K-02, EnvMechSG

Detail Specification reference:

5250/026; 5205/030; 5205/031; 5205/32

Chart F4A	Test	Tick when done	Conditions	Date Code	Tested Qty	N° of Rejects	Comments if not performed. Comments on Rejection
	Mechanical shock		MIL-STD-750 TM2016	2248G 2243F	17 17	0	
	Vibration		MIL-STD-750 TM2056	2248G 2243F	17 17	0	
	Constant acceleration		MIL-STD-750 TM2006	2248G 2243F	17 17	0	
Environmental/Mechanical Subgroup	Seal Fine leak Gross leak		MIL-STD-883 TM1014	2248G 2243F	17 17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
al Su	Electrical Measurement		Intermediate and End-Point Electrical Measurements	2248G 2243F	17 17	0	
nanic	External Visual		ESCC Basic spec 20500	2248G 2243F	17 17	0	
Mech	Thermal shock		MIL-STD-750 TM1056				Temperature Cycling performed
nental/I	Temperature Cycling	×	MIL-STD-883 TM1010	2248G 2243F	17 17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
ironr	Moisture Resistance	×	MIL-STD-750 TM1021	2248G 2243F	17 17	0	
Env	Seal Fine leak Gross leak	×	MIL-STD-883 TM1014	2248G 2243F	17 17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
	Electrical Measurement	$\boxtimes$	Intermediate and End-Point Electrical Measurements	2248G 2243F	17 17	0	
	External Visual		ESCC Basic spec 20500	2248G 2243F	17 17	0	
	Operating Life	×	ESCC 5000 Para. 8.19	2302A	17	0	
nce	Electrical Measurement	$\boxtimes$	Intermediate and End-Point Electrical Measurements	2302A	17	0	
Endurance Subgroup	Seal Fine leak Gross leak		MIL-STD-883 TM1014	2302A	17	0	See Appendix 'A' in ESCC Detail Specifications – Deviations from Chart F4A
	External Visual Inspection		ESCC Basic spec 20500	2302A	17	0	
	Permanence of Marking		ESCC Basic Spec 24800				n.a. due to laser marking
billity	Terminal Strength		ESCC 5000 Para. 8.18	2311A			N/A acc. ESCC Det. Spec 5205/033 §§ 2.1.1.2
Sapa	Terminal Strength		ESCC 5000 Para. 8.18	2234A	6	0	
Assembly Capability Subgroup	Internal Visual		ESCC Basic Spec 20400	2311A 2234A	7 6	0	
Assei	Bond Strength		MIL-STD-750 TM 2037	2311A 2234A	7 6	0	
	Die Shear		MIL-STD-750 TM 2017	2311A 2234A	7 6	0	
Additional Tests	Internal Gas Analyse		MIL-STD-883 TM 2036	2311A	6	0	On BUY65CS08J-02 Report: 2117LR10:l1a
Add							



TRANSISTORS, POWER MOSFET Type BUY \*\*CS\*\*; N-CHANNEL, BASED ON TYP BUY25CS Component title:

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### NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL

ENTRIES	
Form heading	shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
Box 1	shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
Box 2; 3 and 4	As per QPL entry; otherwise, an explanation of the changes must be supplied.
Box 5	Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
Box 6	Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
Box 7	Must reference the report(s) supplied in support of the application.
Box 8	Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
Box 9	If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
Box 10	Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
Box 11	This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
Box 12	Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
Box 13	Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
Box 14	To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
Box 15	Fill in Table as requested.
Box 16	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 17	All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
Box 18	Fill in Table as requested.
Box 19	Confidential Details of PID changes including those of a confidential nature, shall be provided.
Box 20	State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.
Box 21	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 22	Additional Comments.